Challenges for Diamond Sensors for Future HE Frontier Experiments

H. Kagan Ohio State University

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Outline of Talk

- The ATLAS Diamond Detectors ongoing projects
- Metalization/Surface quality
- Sensor Qualification
- Manufacturing/Scale-up
- Geometry
- Summary



• Luminosity at the LHC is rising rapidly - now ~7.5×10³³cm⁻²s⁻¹



- Luminosity is a counting issue requires good segmentation in space or time
- Problems occur when particle multiplicity reaches a point where all segments have high probability of having a hit in every bunch crossing



• Luminosity measurement with the ATLAS diamond BCM



Speed, robustness, stability required for good luminosity



• The BCM rate (speed) is BCID aware



 To provide robust rate measurements suppress backgrounds by 10⁻³-10⁻⁶

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Stable over months

• In 2011 BCM achieved a 1.9% luminosity measurement!



H. Kagan

• Stability of two independent measurements BCMH and BCMV:

The ATLAS Diamond Detectors - lessons

Stable against pile-up



• But the BCM will begin to saturate at $\sim 10^{34}$ cm⁻²s⁻¹:



• More segmentation \rightarrow pixels \rightarrow Diamond Beam Monitor (DBM)





- Build on success of BCM pixelate the sensors
 - Use IBL diamond pixel demonstrator module
 - Install during new Service Quarter Panel (nSQP) replacement
 - Four 3-plane stations on each side of the IR







- 24 diamond pixel modules arranged in 8 telescopes provide
 - Bunch by bunch luminosity monitoring
 - Bunch by bunch beam spot monitoring
- Installation in July 2013







- Specs:
 - Bunch by bunch luminosity monitoring (<1% per BC per LB)
 - Bunch by bunch beam spot monitoring (unbiased sample, ~ 1cm)
- Installation in July 2013

Bonn CERN Göttingen Ljubljana N.Mexico OhioSt Toronto





- Sensors
 - 38 old sensors recycled from E6 (UK) from IBL work
 - 10 new sensors in hand from E6 (UK)
 - 17 sensors ordered from II-VI (US) sensors in processing
- Quality Control
 - 6/38 old sensors + 8/10 new sensors passed full QC (V,I,ccd)
 - 12/38 old sensors + 9/10 new sensors passed reduced QC
- Bump bonding
 - 4 prototype modules bump-bonded by IZM
 - 21 sensors at IZM for bump-bonding



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- HV Problems with first modules
 - Backside metalization goes to the edge of diamond and breaks down
 - Fixed by changing back metalization procedure no longer performed by IZM





Lessons Learned: Testbeam

- Many Testbeam campaigns
 - Oct 11, Mar 12, Jun 12, ...
- Lessons: electronic performance
 - Can not always get calibration/tunings for low threshold performance
 - Need electronics with proper design to take advantage of diamond detector properties



What is possible?

x = October 2011 DBM Test Beam





Prototype Modules Tested:

- 21mmx 18mm pCVD diamond w/FE-I4
- 336 x 80 = 26880 channels
- 50 x 250 µm² pixel cell

Results

- Noise map uniform
- Efficiency >95%











Prototype Modules Tested:

- 21mmx 18mm pCVD diamond w/FE-I4A
- 336 x 80 = 26880 channels
- 50 x 250 µm² pixel cell

Results

• Spatial resolution looks digital







Future detectors will require 10x - 100x more devices





After last RD42 meeting learned that DDL had ceased operations



DIAMOND DETECTORS LTD

Dear Customer

Diamond Detectors Limited

It is with regret that we announce that we have taken the decision to close the business.

Operations will cease on 25 May 2012. Please be advised that existing orders will not be completed and no future orders will be accepted. We apologise for any inconvenience this may cause.

•After scrambling E6 filled ATLAS order





Production and Scale-up demand additional manufacturers:

- * For ATLAS DBM it was DDL & II-VI \rightarrow E6 & II-VI
- II-VI now online
- Micron Semiconductor has purchased some of DDL equipment and personnel interested in diamond devices
- Two other US companies are now manufacturing diamond

Material Qualification requires detailed tests

Must avoid defects and dislocations





And surface preparation (last 5µm) is critical:

Sub-surface damage effects



The Problem: measured w/source

After: Measured in Test beam



It can take a very long time to qualify additional manufacturers:

• II-VI has now produced large, superb wafers







After severe radiation damage all detectors are trap limited

- Mean free paths < 75 μ m
- Would like to keep drift distances smaller than mfp



Can one make conducting hole structures in diamond?





Collaboration of: ETH-Z, Manchester, Ohio State, Saclay, CERN in RD42

- Holes drilled with femto-second laser
- Operate planar (500V), 3D(no-holes) (25V), 3D (25V)
- Simultaneous comparison on same diamond
- Analysis/simulation first results \rightarrow Iain Haughton's Talk

















Configure 3D devices as strip detectors

- use VA2.2 electronics, test in beam at CERN
- Comparison of 3D(no-hole) w/Planar



channel of highest Signa 70 62 60 61 60 50 59 40 58 30 57 20 56 10 55 500 1000 1500 2000 2500 0 Charge of Cluster in ADC counts SVN-Rev: exported Run 17107 800000 Events in Data Set 2013-02-08 16:35:23



charge of cluster - cluster size 1 or 2 - no border hits - 3D without holes: ch 55-63



Configure 3D devices as strip detectors

- use VA2.2 electronics, test in beam at CERN
- Comparison of 3D w/Planar





charge of cluster - cluster size 1 or 2 - no border hits - 3D with holes: ch 85-93







Configure 3D devices as strip detectors

- use VA2.2 electronics, test in beam at CERN
- Comparison of 3D w/ 3D(no-hole)





charge of cluster - cluster size 1 or 2 - no border hits - 3D with holes: ch 85-93









Construction of the largest diamond pixel tracker underway Many design issues were brought to light: speed, robustness, stability, segmentation Many issues needed attention: metalization, electronics, sensor qualification, suppliers Some beliefs were modified or need more effort: recycling/re-use New geometry had initial successes: 3D structures in diamond work - see Iain Haughton's Talk





Backup Slides

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- Simulate DBM to find orientation and resolution
 - Focus on z vertex resolution (momentum resolution bad)







• Cooling simulations for DBM telescope w/3 x 1W + AIN side plate





• Mechanical simulations for DBM telescope $w/3 \times 1W + AIN$ side plate

